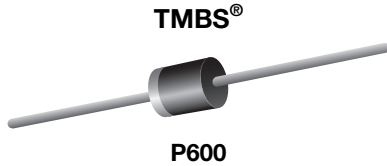


Photovoltaic Solar Cell Protection Schottky Rectifier

 Ultra Low $V_F = 0.30\text{ V}$ at $I_F = 5.0\text{ A}$


FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- High forward surge capability
- ESD capability
- High junction temperature 230 °C maximum at DC forward current
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	20 A
V_{RRM}	45 V
I_{FSM}	250 A
V_F at $I_F = 20\text{ A}$	0.42 V
T_{OP} max. (AC mode)	150 °C
T_J max. (DC forward current)	230 °C
Package	P600
Diode variation	Single die

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: P600

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	VSB2045Y	UNIT
Device marking code		V2045Y	
Maximum repetitive peak reverse voltage	V_{RRM}	45	V
Maximum average forward rectified current (fig. 1)	$I_{F(DC)}^{(1)}$	20	A
	$I_{F(DC)}^{(2)}$	6.5	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	250	A
Operating junction temperature range	T_{OP}	-40 to +150	°C
Storage temperature range	T_{STG}	-40 to +175	°C
Junction temperature in DC forward current without reverse bias, $t \leq 1\text{ h}$	$T_J^{(1)}$	≤ 230	°C

Notes

(1) With heatsink

(2) Without heatsink, free air



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 5.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.44	-	V
	$I_F = 10\text{ A}$			0.46	-	
	$I_F = 20\text{ A}$			0.50	0.58	
	$I_F = 5.0\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.30	-	
	$I_F = 10\text{ A}$			0.35	-	
	$I_F = 20\text{ A}$			0.42	0.50	
Reverse current	$V_R = 45\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	23.4	1200	μA
		$T_A = 125\text{ }^\circ\text{C}$		11.9	35	mA
Typical junction capacitance	4.0 V, 1 MHz	C_J	2050	-	pF	

Notes(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: 40 ms pulse width

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	VSB2045Y	UNIT
Thermal resistance	$R_{\theta JA}^{(1)}$	55	$^\circ\text{C/W}$
	$R_{\theta JL}^{(1)}$	3.5	
Typical thermal resistance	$R_{\theta JL}^{(2)}$	2.5	$^\circ\text{C/W}$

Notes

(1) Without heatsink, free air; units mounted on PCB with 2 mm x 2 mm copper pad areas at 9.5 mm lead length

(2) Leads clipped at 3 mm lead length from plastic body on 7.0 cm x 2.2 cm x 1.9 cm x 2 heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
JESD22-A114	Human body model (contact mode)	$C = 150\text{ pF}$, $R = 1.5\text{ }\Omega$	V_C	3B	> 8 kV
JESD22-A115	Machine model (contact mode)	$C = 200\text{ pF}$, $R = 0\text{ }\Omega$		C	> 400 V
IEC 61000-4-2 ⁽²⁾	Human body model (air discharge mode) ⁽¹⁾	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$		4	> 15 kV

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 25 kV

(2) System ESD standard

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
VSB2045Y-M3/54	1.88	54	800	13" diameter paper tape and reel
VSB2045Y-M3/73	1.88	73	300	Ammo pack packaging

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

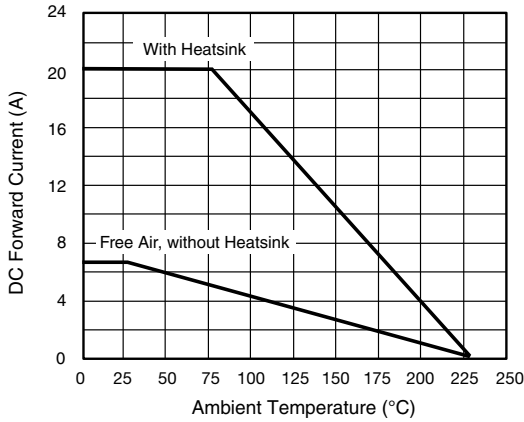


Fig. 1 - Forward Current Derating Curve

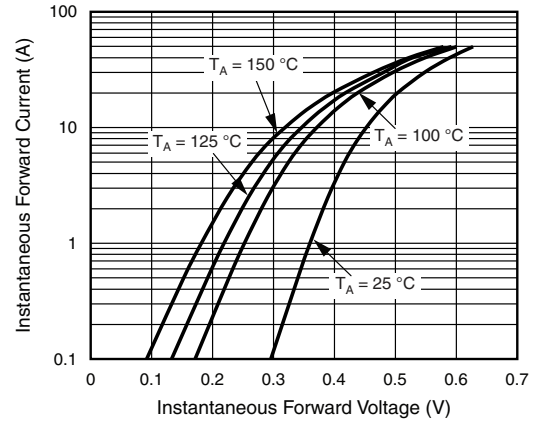


Fig. 4 - Typical Instantaneous Forward Characteristics

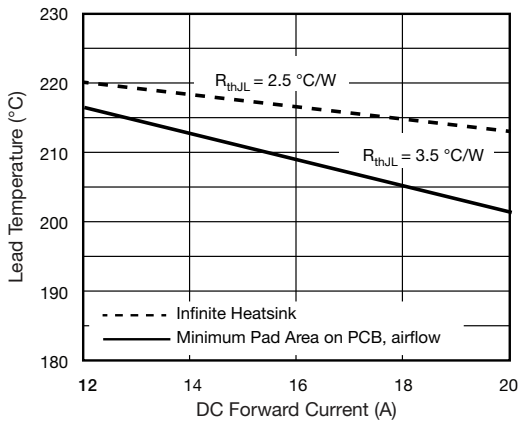


Fig. 2 - Rated Forward Current vs. Ambient Temperature

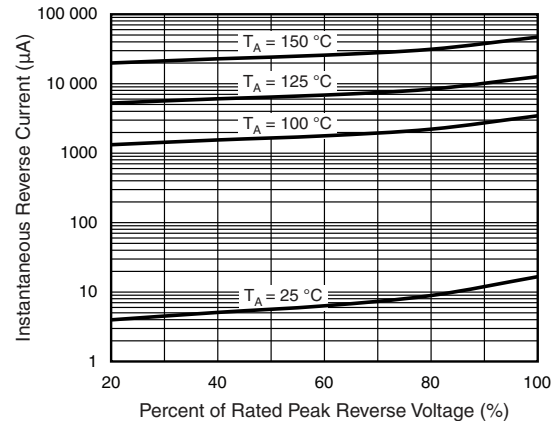


Fig. 5 - Typical Reverse Leakage Characteristics

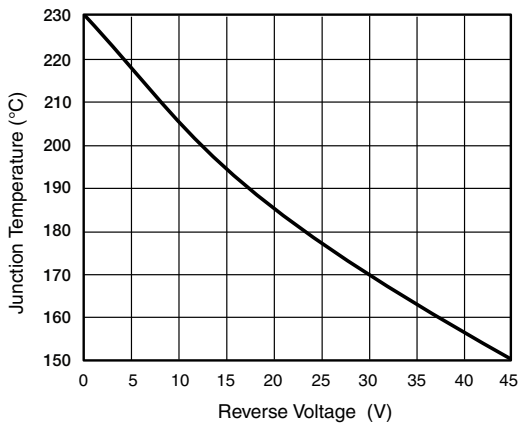


Fig. 3 - Forward Power Loss Characteristics

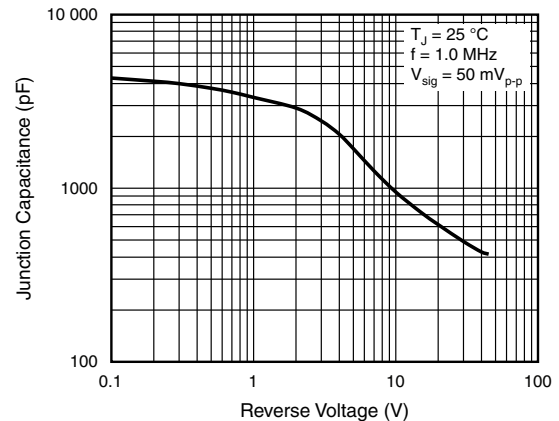
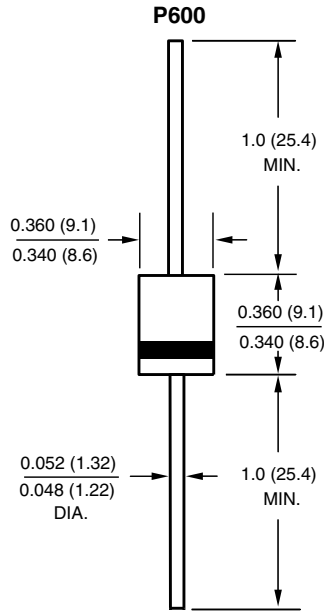


Fig. 6 - Typical Junction Capacitance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9